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PLASTIC INTEGRATED CIRCUIT PACKAGE AND METHOD AND

LEADFRAME FOR MAKING THE

PACKAGE

First Named Inventor:

THOMAS GLENN

Domestic/Foreign Application:

Domestic Application

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Title of Invention

PLASTIC INTEGRATED CIRCUIT PACKAGE AND METHOD AND LEADFRAME FOR MAKING THE PACKAGE

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10/626150

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First Named Applicant:

THOMAS P.

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MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney	

Documents being submitted

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ids4-usidst.xml

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Comments



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

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Art Unit:

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Search string:

(5886398 or 5894108 or 5897339 or 5900676 or 5903049 or 5903050 or 5909053 or 5915998 or 5917242 or 5939779 or 5942794 or 5951305 or 5959356 or 5969426 or 5973388 or 5976912 or 5977613 or 5977615 or 5977630 or 5981314 or 5986333 or 5986885 or 6001671 or 6013947 or 6018189 or 6020625 or 6025640 or 6031279 or 6034423 or RE36613 or 6040626 or 6043430 or 6060768 or 6060769 or 6072228 or 6075284 or 6081029 or 6084310 or 6087715 or 6087722 or 6100594 or 6114752 or 6113474 or 6118174 or 6118184 or 6130115 or 6130473 or RE36607 or

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Signature

Examiner Name	Date
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